T1210T-8FP

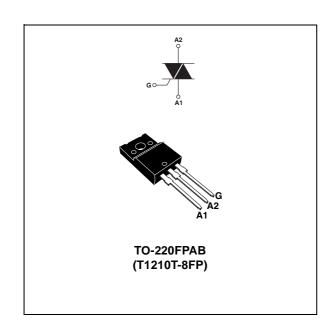
life.augmented

12 A logic level Triac

Datasheet – production data

V

mΑ



Description

V_{DSM}, V_{RSM} I_{GT}

Available in through-hole fullpack package, the T1210T-8FP Triac can be used for the on/off or phase angle control function in general purpose AC switching. This device can be directly driven by a microcontroller thanks to its 10 mA gate current requirement.

Provides UL certified insulation rated at 1500 V rms.

| Table 1. Device summary | | | | | |
|-------------------------------------|-------|------|--|--|--|
| Symbol | Value | Unit | | | |
| I _{T(rms)} | 12 | А | | | |
| V _{DRM} , V _{RRM} | 800 | V | | | |

900

10

Features

- Three triggering quadrants Triac
- ECOPACK[®]2 compliant component
- Complies with UL insulation safety standards (File ref: E81734)
- High performance Triac:
 - High T_i family
 - High dl/dt family
 - High dV/dt family

Applications

- General purpose AC line load switching
- Motor control circuits
- Small home appliances
- Lighting control
- Inrush current limiting circuits
- Overvoltage crowbar protection

1 Characteristics

| Symbol | Symbol Parameter | | | | |
|--|---|--------------------------------|-------------------------|---------------|------|
| I _{T(rms)} | On-state rms current (full sine wave | rrent (full sine wave) | | 12 | А |
| I | Non repetitive surge peak on-state | F = 50 Hz | t = 20 ms | 90 | А |
| I _{TSM} | current (full cycle, T _j initial = 25 °C) | F = 60 Hz | t = 16.7 ms | 95 | ~ |
| l²t | $I^{2}t$ value for fusing, T_{j} initial = 25 °C | | t _p = 10 ms | 54 | A²s |
| V _{DRM} , | Ropotitivo surgo poak off stato volta | T _j = 150 °C | 600 | V | |
| V _{RRM} | | | T _j = 125 °C | 800 | v |
| V _{DSM} , V _{RSM} | Non repetitive surge peak off-state | e surge peak off-state voltage | | 900 | V |
| dl/dt | Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100$ ns | F = 100 Hz | | 100 | A/µs |
| I _{GM} | Peak gate current | t _p = 20 μs | T _j = 150 °C | 4 | А |
| P _{G(AV)} | Average gate power dissipation | 1 | W | | |
| T _{stg} | Storage junction temperature range | | | - 40 to + 150 | °C |
| Тj | Operating junction temperature range | - 40 to + 150 | 0 | | |
| ΤL | Maximum lead temperature for sold | ering during | 10 s | 260 | °C |
| V _{ins} | Insulation rms voltage, 1 minute | | | 1500 | V |

| Symbol | Test conditions | Quadrant | | Value | Unit | |
|--------------------------------|---|-------------------------|------|-------|--------|--|
| I _{GT} ⁽¹⁾ | $V_{D} = 12 V, R_{I} = 30 \Omega$ - - | | Min. | 0.5 | m۸ | |
| I'GT ` | $V_{D} = 12 V, R_{L} = 30 \Omega$ | 1 - 11 - 111 | Max. | 10 | mA | |
| V _{GT} | V_D = 12 V, R _L = 30 Ω | 1 - 11 - 111 | Max. | 1.3 | V | |
| V _{GD} | $V_D = V_{DRM}, R_L = 3.3 \text{ k} \Omega, T_j = 150 \text{ °C}$ | 1 - 11 - 111 | Min. | 0.2 | V | |
| I _H ⁽¹⁾ | I _H ⁽¹⁾ I _T = 500 mA | | Max. | 15 | mA | |
| | $I_{G} = 1.2 I_{GT}$ | 1 - 111 | Max. | 20 | mA | |
| ΙL | | Ш | Max. | 25 | mA | |
| dV/dt ⁽¹⁾ | $V_D = V_R = 536 V$, gate open | T _j = 125 °C | Min. | 250 | V/µs | |
| | $V_D = V_R = 402 V$, gate open | T _j = 150 °C | | 170 | V/µs | |
| (dl/dt)c ⁽¹⁾ | (d)/(dt) = 0.1)/(u) | T _j = 125 °C | Min. | 11.7 | A/ms | |
| | $(dV/dt)c = 0.1 V/\mu s$ | T _j = 150 °C | | 8.2 | AVIIIS | |
| (dl/dt)c ⁽¹⁾ | (dV/dt)c = 10 V/µs | T _j = 125 °C | Min. | 6 | A / | |
| | | T _j = 150 °C | | 2.7 | A/ms | |

1. For both polarities of A2 referenced to A1

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| Symbol | Test conditions | | | | Unit | |
|--------------------------------|---|-------------------------|--------|------|------|--|
| V _T ⁽¹⁾ | I _{TM} = 17 A, t _p = 380 μs | T _j = 25 °C | Max. | 1.55 | V | |
| V _{t0} ⁽¹⁾ | Threshold voltage | T _j = 150 °C | Max. | 0.85 | V | |
| R _d ⁽¹⁾ | Dynamic resistance | T _j = 150 °C | Max. | 37 | mΩ | |
| | V _{DRM} = V _{RRM} = 800 V | T _j = 25 °C | Max. | 7.5 | μA | |
| I _{DRM} | | T _j = 125 °C | IVIAX. | 1 | mA | |
| 'KKIM | $V_{\text{DRM}} = V_{\text{RRM}} = 600 \text{ V}$ | T _j = 150 °C | Max. | 2.7 | IIIA | |

| Table 4 | 4. Static | Characteristics |
|---------|-----------|-----------------|
|---------|-----------|-----------------|

1. For both polarities of A2 referenced to A1

| Symbol | SymbolParameterRth(j-c)Junction to case (AC)Rth(j-a)Junction to ambient (DC) | | Unit |
|----------------------|--|--|------|
| R _{th(j-c)} | | | °C/W |
| R _{th(j-a)} | | | °C/W |

Figure 1. Maximum power dissipation versus on-state rms current (full cycle)

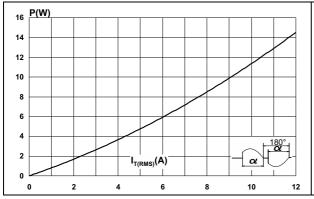
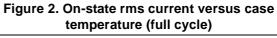


Figure 3. On-state rms current versus ambient temperature (free air convection)



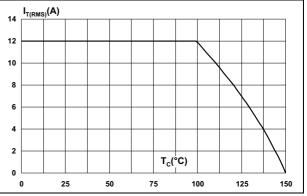
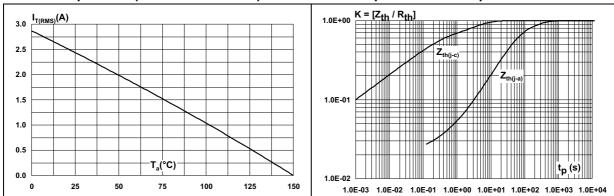


Figure 4. Relative variation of thermal impedance versus pulse duration





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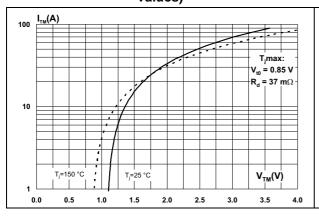


Figure 7. Non repetitive surge peak on-state current and corresponding values of I²t

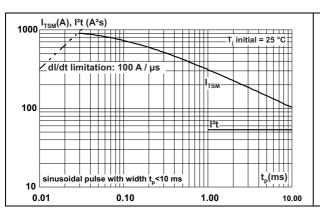
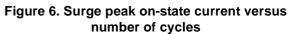


Figure 9. Relative variation of static dV/dt immunity versus junction temperature (typical values)



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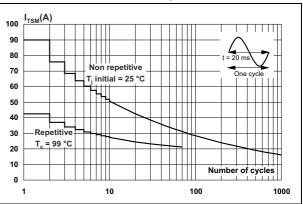
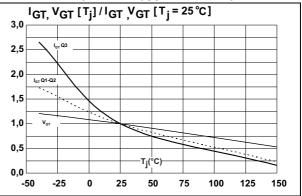
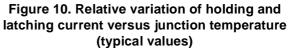


Figure 8. Relative variation of gate trigger current and gate voltage versus junction temperature (typical values)





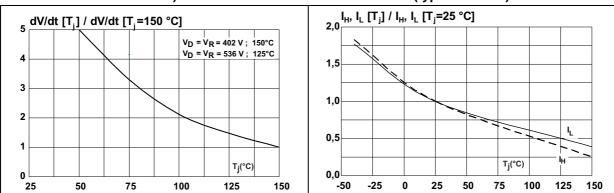
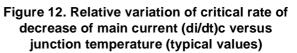


Figure 11. Relative variation of critical rate of decrease of main current (di/dt)c versus reapplied (dV/dt)c (typical values)



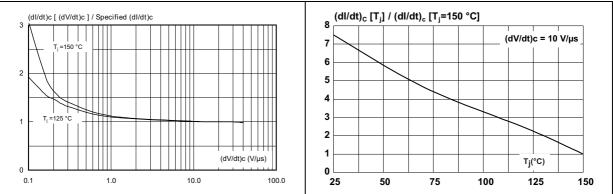
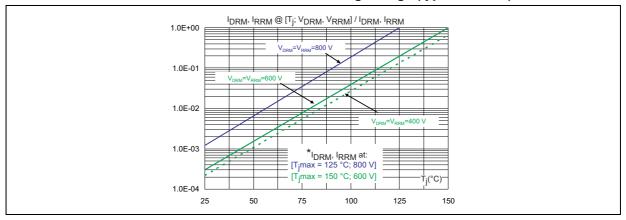


Figure 13. Relative variation of leakage current versus junction temperature for different values of blocking voltage (typical values)

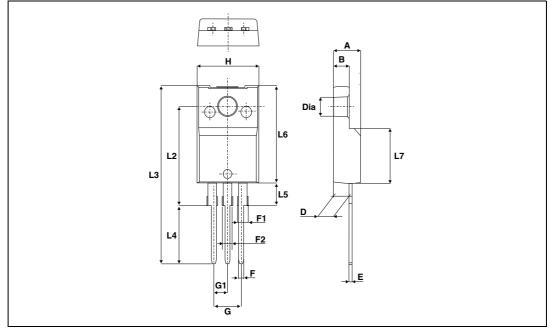




2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.







| Dimensions | | | | | | | | |
|------------|--------|-------|------------|-------|--|--|--|--|
| Ref. | Millim | eters | Inches | | | | | |
| | Min. | Max. | Min. | Max. | | | | |
| А | 4.4 | 4.6 | 0.173 | 0.181 | | | | |
| В | 2.5 | 2.7 | 0.098 | 0.106 | | | | |
| D | 2.5 | 2.75 | 0.098 | 0.108 | | | | |
| E | 0.45 | 0.70 | 0.018 | 0.027 | | | | |
| F | 0.75 | 1 | 0.030 | 0.039 | | | | |
| F1 | 1.15 | 1.70 | 0.045 | 0.067 | | | | |
| F2 | 1.15 | 1.70 | 0.045 | 0.067 | | | | |
| G | 4.95 | 5.20 | 5.20 0.195 | | | | | |
| G1 | 2.4 | 2.7 | 0.094 | 0.106 | | | | |
| Н | 10 | 10.4 | 0.393 | 0.409 | | | | |
| L2 | 16 T | yp. | 0.63 | Тур. | | | | |
| L3 | 28.6 | 30.6 | 1.126 | 1.205 | | | | |
| L4 | 9.8 | 10.6 | 0.386 | 0.417 | | | | |
| L5 | 2.9 | 3.6 | 0.114 | 0.142 | | | | |
| L6 | 15.9 | 16.4 | 0.626 | 0.646 | | | | |
| L7 | 9.00 | 9.30 | 0.354 | 0.366 | | | | |
| Dia. | 3.00 | 3.20 | 0.118 | 0.126 | | | | |

Table 6. TO-220FPAB dimension values



3 Ordering information

| - • • • | ł | 12 | 10 | 1 | - 8 | FP |
|---|----|--------|--------|---|-----|----|
| Triac | | | | | | |
| Current | | | | | | |
| 12 = 12 A | | | | | | |
| Gate sensitivity 10 = 10 mA | | | | | | |
| 10 = 10 mA | | | | | | |
| Specific application | | | | | | |
| T = Increased (dI/dt)c and dV/dt producing reduced I | SM | | | _ | | |
| Voltage (VDDM. VDDM) | | | | | | |
| Voltage (V _{DRM} , V _{RRM}) 8 = 800 V | | | | | | |
| Package | | | | | | |
| FP = TO-220FPAB | | | | | | |

Figure 15. Ordering information scheme

Table 7. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|------------|------------|------------|--------|----------|---------------|
| T1210T-8FP | T1210T-8FP | TO-220FPAB | 2.0 g | 50 | Tube |

4 Revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 31-Jan-2014 | 1 | Initial release. |



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